

Vishay Siliconix

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)			
30	0.0095 at V _{GS} = 10 V	17	8 nC			
30	0.013 at $V_{GS} = 4.5 \text{ V}$	14.5	610			

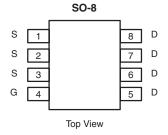
FEATURES

- Halogen-free According to IEC 61249-2-21
- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested

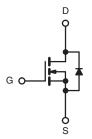
HALOGEN FREE

APPLICATIONS

- Notebook CPU Core
 - High-Side Switch



Ordering Information: Si4174DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

Parameter Drain-Source Voltage Gate-Source Voltage		Symbol	Limit	Unit ∨	
		V _{DS}	30		
		V_{GS}	± 20		
	T _C = 25 °C		17		
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C	1_	13.5		
Continuous Diam Current (1) = 130 °C)	T _A = 25 °C	- ID	12 ^{b, c}		
	T _A = 70 °C		9.6 ^{b, c}		
Pulsed Drain Current		I _{DM}	50	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	1-	4.5		
Continuous Source-Drain Diode Current	T _A = 25 °C	- Is	2.2 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20		
Avalanche Energy	L=0.1 IIII	E _{AS}	20	mJ	
	T _C = 25 °C		5		
Maximum Dawar Dissination	T _C = 70 °C	P _D	3.2	w	
Maximum Power Dissipation	T _A = 25 °C	- FD	2.5 ^{b, c}	vv	
	T _A = 70 °C		1.6 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	38	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	20	25	<i>5/VV</i>		

- a. Based on T_C = 25 °C.
 b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 $^{\circ}\text{C/W}.$

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			٧
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L = 250 uA		34		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = 250 μA		- 4.7		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.0		2.2	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zava Cata Valtaga Duais Courset	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C			10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
		V _{GS} = 10 V, I _D = 10 A		0.0078	0.0095	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 7 A		0.0108	0.0130	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		30		S
Dynamic ^b						
Input Capacitance	C _{iss}			985		
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		205		pF
Reverse Transfer Capacitance	C _{rss}	30 30		76		
		V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A		18	27	
Total Gate Charge	Q _g			8	12	nC
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		2.4		
Gate-Drain Charge	Q _{gd}			2.3		
Gate Resistance	R_g	f = 1 MHz	0.3	1.3	2.6	Ω
Turn-On Delay Time	t _{d(on)}			14	25	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		12	24	ns
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		19	35	
Fall Time	t _f			9	18	
Turn-On Delay Time	t _{d(on)}			8	16	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		10	20	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		16	30	
Fall Time	t _f			9	18	
Drain-Source Body Diode Characteristi	cs				_	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			4.5	
Pulse Diode Forward Current ^a	I _{SM}				50	Α
Body Diode Voltage	V _{SD}	I _S = 3 A		0.76	1.1	V
Body Diode Reverse Recovery Time	t _{rr}	_		14	28	ns
Body Diode Reverse Recovery Charge	Q _{rr}	1		5	10	nC
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		8		
Reverse Recovery Rise Time	t _b			6		ns

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

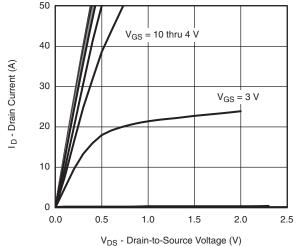
a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

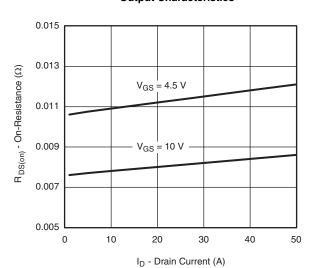


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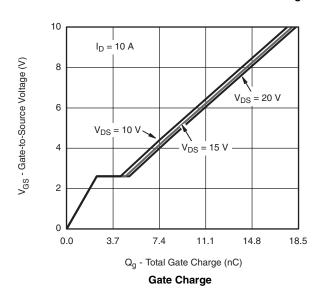
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Output Characteristics



On-Resistance vs. Drain Current and Gate Voltage



8.0

6.4

TC = 25 °C

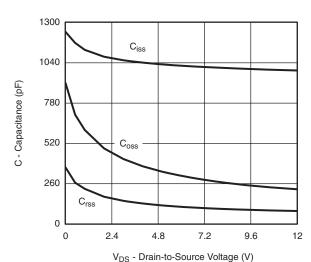
TC = 125 °C

TC = - 55 °C

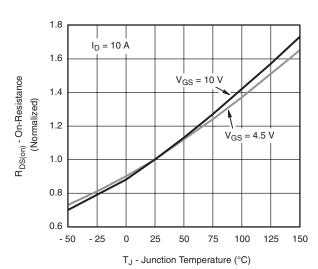
0.0

0 1 2 3 4 5

V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**



Capacitance



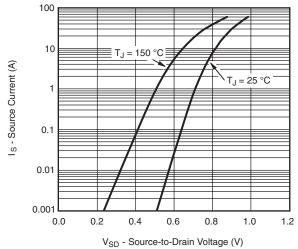
On-Resistance vs. Junction Temperature

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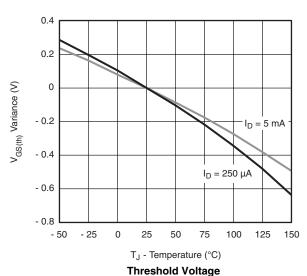
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

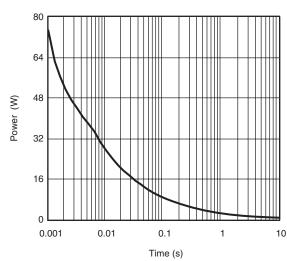


Source-Drain Diode Forward Voltage

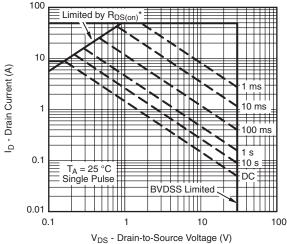


0.05 $I_D = 10 \text{ Å}$ 0.04 $R_{DS(on)}$ - On-Resistance (Ω) 0.03 0.02 $T_J = 125$ °C 0.01 T_J = 25 °C 0.00 0 3 4 5 8 9 10

 $\label{eq:VGS} V_{GS} \mbox{ - Gate-to-Source Voltage (V)} \\$ On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



VDS - Diam-to-Source voltage (v)

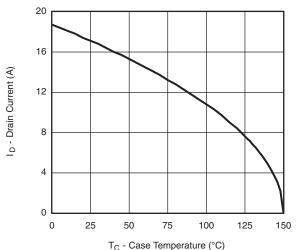
* $V_{GS} > \mbox{minimum } V_{GS}$ at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

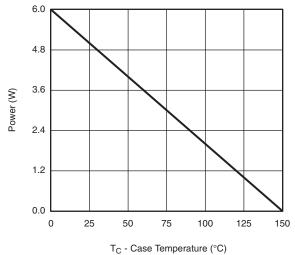


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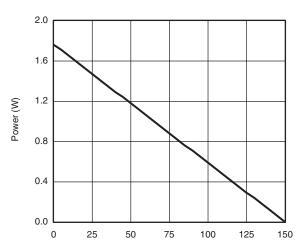
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*



Power, Junction-to-Ambient



 T_A - Ambient Temperature (°C) Power Derating, Junction-to-Foot

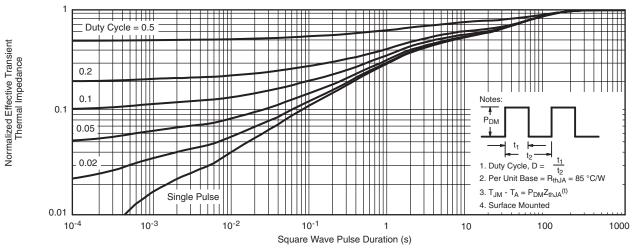
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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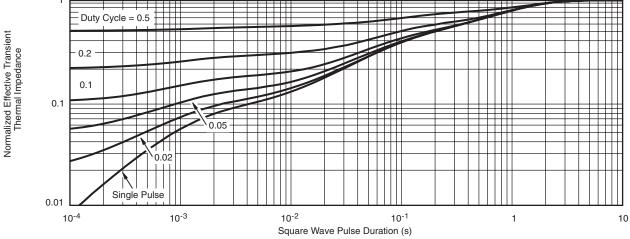
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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